

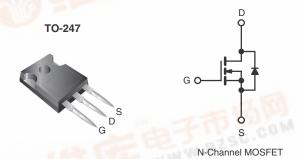
Vishay Siliconix

RoHS

COMPLIANT

WWW.DZSC **Power MOSFET**

PRODUCT SUMMARY					
V _{DS} (V)	400	400			
R _{DS(on)} (Ω)	V _{GS} = 10 V	0.30			
Q _g (Max.) (nC)	76	120 124			
Q _{gs} (nC)	20	CC.COM			
Q _{gd} (nC)	37	37			
Configuration	Single	Single			



FEATURES

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement
- Enhanced 30V V_{GS} Rating
- Reduced C_{iss}, C_{oss}, C_{rss}
- Isolated Central Mounting Hole
- Dynamic dV/dt Rated
- · Repetitive Avalanche Rated
- · Lead (Pb)-free Available

DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional MOSFETs. Utilizing advanced MOSFETs technology the device improvements allow for reduced gate drive requirements, faster switching speeds and increased total system savings. These device improvements combined with the proven ruggedness and reliability of MOSFETs offer the designer a new standard in power transistors for switching applications. The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole.

ORDERING INFORMATION	TTT LICOM
Package	TO-247
Lead (Pb)-free	IRFP350LCPbF
	SiHFP350LC-E3
SnPb	IRFP350LC
	SiHFP350LC

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V_{DS}	400	V	
Gate-Source Voltage	V _{GS}	± 30		
Continuous Drain Current	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$		16	7 19-9
Continuous Diam Current	V_{GS} at 10 $V_{C} = 100 ^{\circ}C$	I _D	9.9	A
Pulsed Drain Current ^a	I _{DM}	64		
Linear Derating Factor		COLUMN TWO	1.5	W/°C
Single Pulse Avalanche Energy ^b	E _{AS}	390	mJ	
Repetitive Avalanche Current ^a		I _{AR}	16	Α
Repetitive Avalanche Energy ^a		E _{AR}	19	mJ
Maximum Power Dissipation	T _C = 25 °C	P _D	190	W
Peak Diode Recovery dV/dtc	dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	
Mounting Torque	6 22 or M2 corow		10	lbf ⋅ in
	6-32 or M3 screw		1.1	N · m

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD}=25$ V, starting $T_J=25$ °C, L=2.7 $\mu H,~R_G=25$ $\Omega,~I_{AS}=16$ A (see fig. 12). c. $I_{SD}\leq 16$ A, $I_{AS}=16$ A

6 mm from case.

Po containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.65	

PARAMETER	SYMBOL	TEST (TEST CONDITIONS		TYP.	MAX.	UNIT
Static					•	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.49	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V$	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	4.0	V
Gate-Source Leakage	I_{GSS}	V _{GS} = ± 20 V		ı	-	± 100	nA
Zero Gate Voltage Drain Current	lana	V _{DS} = 400 V, V _{GS} = 0 V		ı	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 320 \text{ V}, \text{ V}$	$I_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	ı	-	250	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 9.6 A^b$	1	-	0.30	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 50 V, I _D = 19 A ^b		8.1	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		ı	2200	-	pF
Output Capacitance	C _{oss}			ı	390	-	
Reverse Transfer Capacitance	C_{rss}	f = 1.0 MHz, see fig. 5		ı	31	-	
Total Gate Charge	Q_g		$I_D = 16 \text{ A}, V_{DS} = 320 \text{ V}$	ı	-	76	
Gate-Source Charge	Q_gs	V _{GS} = 10 V		ı	-	20	nC
Gate-Drain Charge	Q_{gd}		see fig. 6 and 13 ^b	-	-	37	
Turn-On Delay Time	t _{d(on)}			-	14	-	
Rise Time	t _r	V _{DD} = 200 V, I _D = 16 A,		-	54	-	ns
Turn-Off Delay Time	t _{d(off)}	$R_G = 6.2\Omega, R_D = 12 \Omega$, see fig. 10 ^b		-	33	-	115
Fall Time	t _f			-	35	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		i	-	16	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	64	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = 16 A, V _{GS} = 0 V ^b		-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 16 A, dI/dt = 100 A/μs ^b		-	440	660	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	4.1	6.2	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D				 L _D)	

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 μs ; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

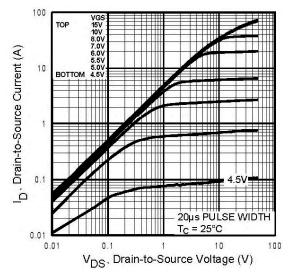


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

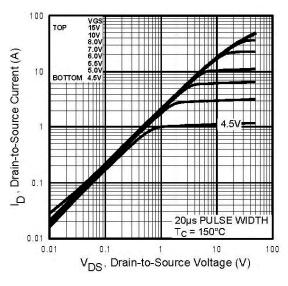


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

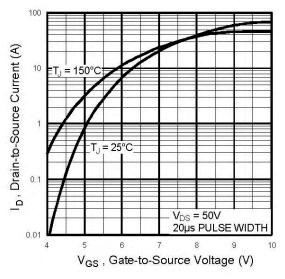


Fig. 3 - Typical Transfer Characteristics

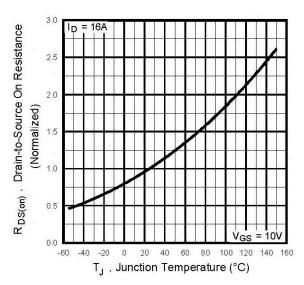


Fig. 4 - Normalized On-Resistance vs. Temperature

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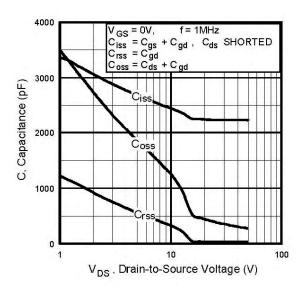


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

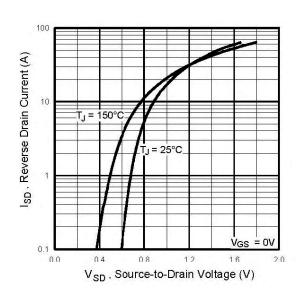


Fig. 7 - Typical Source-Drain Diode Forward Voltage

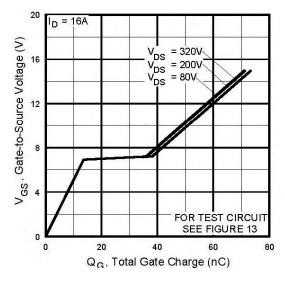


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

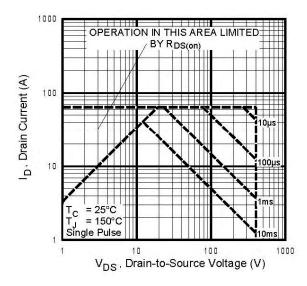


Fig. 8 - Maximum Safe Operating Area

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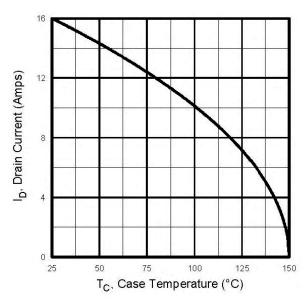


Fig. 9 - Maximum Drain Current vs. Case Temperature

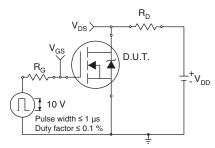


Fig. 10a - Switching Time Test Circuit

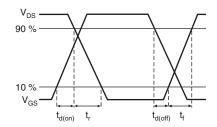


Fig. 10b - Switching Time Waveforms

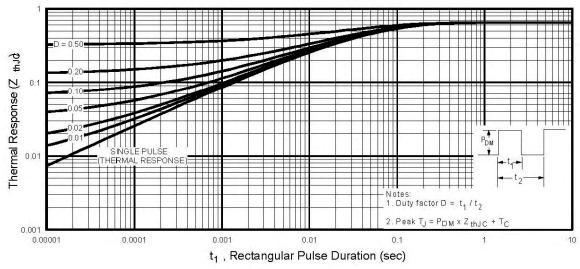


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

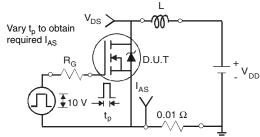


Fig. 12a - Unclamped Inductive Test Circuit

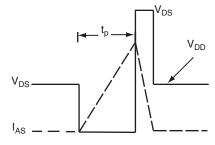


Fig. 12b - Unclamped Inductive Waveforms

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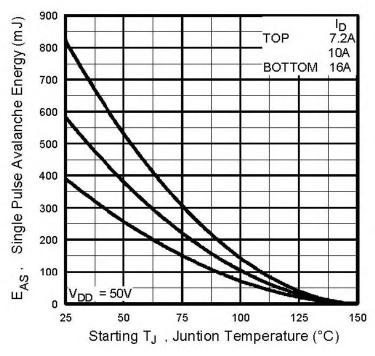


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

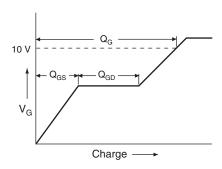


Fig. 13a - Basic Gate Charge Waveform

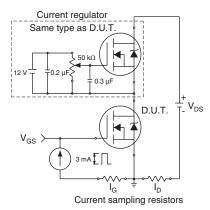


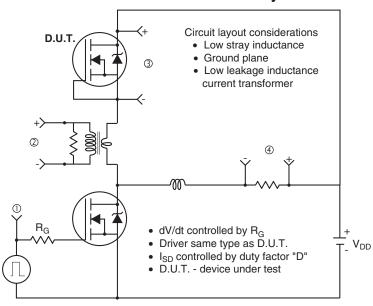
Fig. 13b - Gate Charge Test Circuit

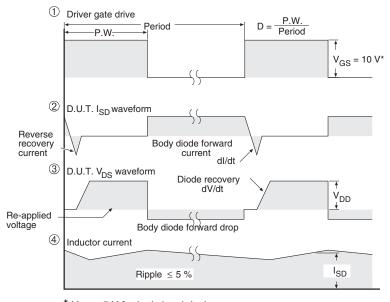
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Peak Diode Recovery dV/dt Test Circuit





* V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Chsannel

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